SN54ABTH25245, SN74ABTH25245 25- Ω OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS251F - JUNE 1992 - REVISED MAY 1997

- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25° C
- High-Impedance State During Power Up and Power Down
- **Designed to Facilitate Incident-Wave** Switching for Line Impedances of 25 Ω or Greater
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- **Package Options Include Plastic** Small-Outline (DW) Package, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) DIPs

description

The 'ABTH25245 are 25- Ω octal bus transceivers designed for asynchronous communication between data buses. They improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented transceivers.

These devices allow noninverted data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can disable the device so that both buses are effectively isolated. When OE is low, the device is active.

These transceivers are capable of sinking 188 mA of I_{OL} current, which facilitates switching 25- Ω transmission lines on the incident wave. The distributed V_{CC} and GND pins minimize switching noise for more-reliable system operation.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.



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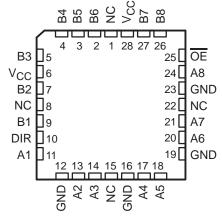
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SN54ABTH25245 JT PACKAGE
SN74ABTH25245 DW OR NT PACKAGE
(TOP VIEW)

A1		U ₂₄] DIR
GND	2	23] B1
A2	[]3	22] B2
A3	4	21	Vcc
GND	5	20] вз
A4	6	19] в4
A5		18] B5
GND	8]]	17] B6
A6	[9	16	Vcc
A7		15] в7
GND	11	14] B8
A8	12	13] <u>oe</u>

SN54ABTH25245 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

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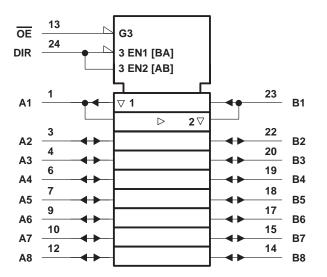
description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABTH25245 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ABTH25245 is characterized for operation from -40° C to 85° C.

	FUNCTION TABLE								
11	NPUTS	OPERATION							
OE	DIR	OPERATION							
L	L	B data to A bus							
L	Н	A data to B bus							
н	Х	Isolation							

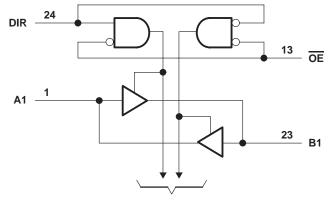
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, and NT packages.



logic diagram (positive logic)



To Seven Other Channels

Pin numbers shown are for the DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} –0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1) –0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, V _O 0.5 V to 5.5 V
Voltage range applied to any output in the high state, V_O
Input clamp current, I _{IK} (V _I < 0) –18 mÅ
Output clamp current, I_{OK} (V _O < 0)
Current into any output in the low state, I _O : SN74ABTH25245 (A port)
SN74ABTH25245 (B port) 128 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package
NT package
Storage temperature range, T _{stg} 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.



SN54ABTH25245, SN74ABTH25245 25- Ω OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS251F - JUNE 1992 - REVISED MAY 1997

recommended operating conditions (see Note 3)

				SN54ABT	125245	SN74ABTI	125245	UNIT
				MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V		
VIH	High-level input voltage			2		2		V
VIL	Low-level input voltage				0.8		0.8	V
VI	Input voltage	0	Vcc	0	VCC	V		
IК	Input clamp current				-18	mA		
lau			A port	40	~ –80		-80	mA
ЮН	High-level output current	B port	45	-32		-32	IIIA	
	Low-level output current		A port	na	188		188	mA
IOL	Low-level output current		B port	64	64		64	IIIA
Δt/Δv	Input transition rise or fall rate	Outputs enabled	Control inputs	Q	4		4	ns/V
ΔυΔν		Outputs enabled	A or B ports		10		10	115/ V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μs/V		
Т _А	Operating free-air temperature			-55	125	-40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.



SN54ABTH25245, SN74ABTH25245 25-Ω OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS251F - JUNE 1992 - REVISED MAY 1997

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			4ABTH2	5245	SN74ABTH25245			UNIT
PAI	RAMEIER	TEST C	UNDITION5	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lj = –18 mA			-1.2			-1.2	V
	A port	V _{CC} = 4.75 V,	I _{OH} = -3 mA	2.7			2.7			
	Apon	V _{CC} = 4.5 V,	I _{OH} =80 mA	2.4			2.4			
VOH		V _{CC} = 4.5 V,	I _{OH} = –3 mA	2.5			2.5			V
	B port	V _{CC} = 5 V,	I _{OH} = –3 mA	3			3			
		V _{CC} = 4.5 V,	I _{OH} = -32 mA	2*			2			
	A port	V _{CC} = 4.5 V	I _{OL} = 94 mA			0.55			0.55	
VOL	A poir	VCC = 4.5 V	I _{OL} = 188 mA			0.7			0.7	V
	B port	V _{CC} = 4.5 V,	I _{OL} = 64 mA			0.55*			0.55	
V _{hys}					100			100		mV
	Control inputs	$V_{CC} = 0$ to 5.5 V,	$V_I = V_{CC} \text{ or } GND$			👌 ±1			±1	μA
ł	A or B ports	V_{CC} = 2.1 V to 5.5 V,	$V_{I} = V_{CC} \text{ or } GND$		±20				±20	μА
I(hold) A or B ports	V _{CC} = 4.5 V	V _I = 0.8 V	100	100 💉 100			μA			
l(hold)	A of B ports		V _I = 2 V	-100		-100			μι	
IOZPU [‡]	-	V_{CC} = 0 to 2.1 V, V_{O} =	0.5 V to 2.7 V, $\overline{OE} = X$		20	±50			±50	μA
IOZPD [‡]		V_{CC} = 2.1 V to 0, V _O =	0.5 V to 2.7 V, OE = X	6) ,	±50			±50	μΑ
loff		V _{CC} = 0,	$V_I \text{ or } V_O \leq 4.5 \text{ V}$	Q		±100			±100	μA
ICEX		V _{CC} = 5.5 V,	V _O = 5.5 V			50			50	μA
IO§	B port	V _{CC} = 5.5 V,	V _O = 2.5 V	-50		-210	-50		-210	mA
		V _{CC} = 5.5 V,	Outputs high			500			500	μA
ICC	Outputs open,	Outputs low			20			20	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			500			500	μΑ
∆ICC¶		$V_{CC} = 5.5 V$, One input Other inputs at V_{CC} or C				1			1	mA
Ci	Control inputs	V _{CC} = 5 V,	$V_I = V_{CC} \text{ or } GND$		4			4		pF
Cio	A or B ports	V _{CC} = 5 V,	$V_{O} = V_{CC} \text{ or } GND$		11.5			11.5		pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] This parameter is characterized, but not production tested.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



SN54ABTH25245, SN74ABTH25245 **25-** Ω OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS251F - JUNE 1992 - REVISED MAY 1997

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V(Tj	CC = 5 V A = 25°C	/, ;	SN54ABTH25245	SN74ABTI	H25245	UNIT
		(001101)	MIN	TYP	MAX	MIN MAX	MIN	MAX	
^t PLH	A or B	B or A	1	2.3	3.5	1	1	3.9	ns
^t PHL	AUB	BUIA	1	2.4	3.5	1 &	1	4.3	115
^t PZH		OE A or B	1.5	3.7	5.4	1.5	1.5	6.5	
^t PZL	OE		1.4	4	5.8	1.4	1.4	6.8	ns
^t PHZ	OE	A or B	2	4.3	6.1	2	2	7.2	
^t PLZ	UE	AUB	2	3.9	5.8	Q 2	2	6.4	ns

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SN54ABTH25245, SN74ABTH25245 25-Ω OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS251F – JUNE 1992 – REVISED MAY 1997

7 V **S1** O Open **500** Ω **From Output** $\Lambda \Lambda A$ TEST **S**1 **Under Test** C GND Open tPLH/tPHL $C_1 = 50 \text{ pF}$ tPLZ/tPZL 7 V **500** Ω (see Note A) tPHZ/tPZH Open LOAD CIRCUIT 3 V **Timing Input** 1.5 V 0 V tw t_{su} th 3 V 3 V Input 1.5 V 1.5 V **Data Input** 1.5 V 1.5 V 0 V 0 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS** PULSE DURATION SETUP AND HOLD TIMES 3 V 3 V Output 1.5 V 1.5 V Input 1.5 V 1.5 V Control 0 V 0 V ^tPZL ^tPHL ^tPLH ^tPLZ Output VOH 3.5 V Waveform 1 1.5 V 1.5 V 1.5 V Output VOI + 0.3 V S1 at 7 V VOL VOL (see Note B) ^tPHZ ^tPLH ^tPHL – ^tPZH ⁻ Output VOH Vон Waveform 2 V_{OH} – 0.3 V 1.5 V 1.5 V 1.5 V Output S1 at Open ≈ 0 V VOL (see Note B) **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES** ENABLE AND DISABLE TIMES INVERTING AND NONINVERTING OUTPUTS LOW- AND HIGH-LEVEL ENABLING

PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABTH25245DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABTH25245DWR	SOIC	DW	24	2000	346.0	346.0	41.0

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